Accredited Standards Committee*

National Committee for Information Technology Standards (NCITS)

Doc. No.: T10/98-125r1

Date: March 30, 1998

Reply to: John Lohmeyer

To: T10 Membership

From: Ralph Weber / John Lohmeyer

Subject: SPI-2 / SPI-3 Working Group Meeting -- March 16, 1998

San Diego, CA

Agenda

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- 2. Approval of Agenda
- 3. Attendance and Membership
- 4. SPI-3 Topics
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 - 4.2 Load Compensation (97-281) [Novak]
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Results of Meeting

1. Opening Remarks

John Lohmeyer, the T10 Chair, called the meeting to order at 9:00 a.m., Monday March 16, 1998. He thanked Skip Jones and QLogic for arranging and hosting the meeting.

As is customary, the people attending introduced themselves and a copy of the attendance list was circulated. John noted that standards cannot contain known patented material unless the patent holder agrees to comply with the ANSI patent policy.

2. Approval of Agenda

The draft agenda was approved with the no additions or changes. No agenda items were added during the course of the meeting.

3. Attendance and Membership

Attendance at working group meetings does not count toward minimum attendance requirements for T10 membership. Working group meetings are open to any person or organization directly and materially affected by T10's scope of work. The following people attended the meeting:

	Name	S 	Organization	Electronic Mail Address
Mr.	Lawrence J. Lamers	Р	Adaptec, Inc.	ljlamers@ix.netcom.com
Mr.	Vincent Bastiani	A#	Adaptec, Inc.	bastiani@corp.adaptec.com
Mr.	Mark Delsman	A#	Adaptec, Inc.	mdelsman@corp.adaptec.com
Mr.	Tak Asami	V	Adaptec, Inc.	asami@itc.adaptec.com
Mr.	Wally Bridgewater	V	Adaptec, Inc.	wally@eng.adaptec.com
Mr.	Bill Gintz	V	Adaptec, Inc.	bgintz@corp.adaptec.com
Mr.	Richard Moore	V	Adaptec, Inc.	richard_moore@corp.
				adaptec.com
Mr.	Tom Schneider	V	Adaptec, Inc.	schneid@itc.adaptec.com
Mr.	Charles Brill	P	AMP, Inc.	cebrill@amp.com
Mr.	Scott Lindstrom	0	AMP, Inc.	slindstr@amp.com
Mr.	Hank Herrmann	V	AMP, Inc.	Hank.Herrmann@amp.com
Mr.	Bill Mable	Α	Amphenol Interconnect	bmable@spectra.net
	Ron Roberts	Α	Apple Computer	rkroberts@aol.com
Mr.	Douglas Wagner	P	Berg Electronics	wagnerdl@bergelect.com
Mr.	Bob Gannon	0	C&M Corp.	rgannon@cm-corp.com
Mr.	Edward Haske	0	CMD Technology	haske@cmd.com
Mr.	Robert C. Elliott	0	Compaq Computer Corp.	relliott@compaq.com
Mr.	Bill Galloway	0	Compaq Computer Corp.	Bill.Galloway@compaq.com
Mr.	Charles Tashbook	P	Dallas Semiconductor	charles.tashbook@dalsemi.
				COM
Mr.	Greg McSorley	P	Data General / Clariion	<pre>greg_mcsorley@dgc.ceo.dg.</pre>
				COM
Dr.	William Ham	A#	Digital Equipment Corp.	bill.ham@digital.com
Mr.	George Penokie	P	IBM Corp.	gop@us.ibm.com
Mr.	Dan Colegrove	A#	IBM Corp.	colegrov@us.ibm.com
Mr.	Dennis Moore	P	KnowledgeTek, Inc.	dmoore@ix.netcom.com
Mr.	Dean Wallace	P	Linfinity Micro	75671.3443@compuserve.com
Mr.	Alan Littlewood	Ρ	LSI Logic Corp.	alanl@lsil.com
	Jay Neer	A	Molex Inc.	jneer@molex.com
	Chris Millsaps	V	Mylex Corp.	chrism@mylex.com
	Skip Jones	P	QLogic Corp.	sk_jones@qlc.com
Mr.	Ting Li Chan	A	QLogic Corp.	t_chan@qlc.com
	Chuck Micalizzi	V	QLogic Corp.	c_micalizzi@qlc.com
	Patrick McGarrah	Ρ	Quantum Corp.	pat.mcgarrah@quantum.com
	James McGrath	A#	Quantum Corp.	JMCGRATH@QNTM.COM
	Bruce Leshay	V	Quantum Corp.	bleshay@tdh.qntm.com
Mr.	Richard Uber	V	Quantum Corp.	duber@tdh.qntm.com

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Mr. Gene Milligan
                            P Seagate Technology
                                                                  Gene_Milligan@notes.
                                                                seagate.com
Mr. Gerald Houlder
                            A Seagate Technology
                                                                 Gerry_Houlder@notes.
                                                                seagate.com
Mr. John M. Wright V Seagate Technology
                                                                 John_M_Wright@notes.
                                                                seagate.com
Mr. Dave Guss P Silicon Systems, Inc. dave.guss@tus.ssil
Mr. Vit Novak A Sun Microsystems, Inc. vit.novak@sun.com
Mr. John Lohmeyer P Symbios, Inc. lohmeyer@ix.netcom
Mr. Ralph O. Weber A Symbios, Inc. roweber@acm.org
Mr. Graeme Weston- A# Symbios, Inc. gwl@symbios.com
                                                                 dave.guss@tus.ssi1.com
                                                                 lohmeyer@ix.netcom.com
                                                      gwl@symbios.com
Lewis
Mr. Frank Gasparik V Symbios, Inc.
                                                                 frank.gasparik@symbios.
Mr. Steve Stefek V Symbios, Inc. steve.stefek@symbios.com
Mr. Paul D. Aloisi P Unitrode Corporation aloisi@unitrode.com
Mr. Jeffrey L. P Western Digital Jeffrey.L.Williams@wdc.
                                                               com
Williams
                                Corporation
Mr. Gregory Kapraun A Western Digital
                                                                Gregory.D.Kapraun@wdc.com
                                 Corporation
48 People Present
Status Key: P - Principal
                 A,A# - Alternate
                 O - Observer
                 L - Liaison
                 V - Visitor
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4. SPI-3 Topics

4.1 Staged Contact Resistance (98-xxx) [Herrman]

Hank Herrman noted that AMP had applied for a patent related to the material to be presented. He expected that AMP would comply with the ANSI patent policy should the material be included in SPI-3.

Hank presented an analysis of signal behavior on connector mating. The analysis included a model for initial contact (touching of conductors) and several other properties of connector mating behavior. Hank showed signal traces based on the model for transients caused by contact mating. He then described a mechanical change to the contact surfaces that would introduce several levels of resistance in the contacts with the effect that the transients are reduced.

The AMP testing had been done with the staged-resistance contacts on the device connector. John Lohmeyer asked about placing the special staged-resistance contacts on the host connector so that the extra costs associated with hot-plugging would only affect those systems that need hot-plugging. The question was not really answered and remains an open issue.

The group expressed interest in the connector design and the hope that such a design would make hot-plugging more reliable for parallel SCSI busses. It was felt that more discussions would be required before a specific proposal could be made.

4.2 Load Compensation (97-281) [Novak]

Vit Novak followed-up on his presentation from the previous meeting showing how compensating circuitry can be placed on a backplane to improve the signal quality seen by devices. He noted that many components are required

to support a typical backplane and suggested that the components might be applied to sets of around three drives with equal effectiveness, thus reducing the cost.

Bill Ham asked the group to think about where the information could be placed. George Penokie suggested an informative annex in SPI-3. Vit indicated that the ideas presented are not needed for LVD SCSI and would be useful only for higher transfer rates, thus confirming that SPI-3 would be more appropriate than SPI-2.

4.3 Universal Backplane Annex (98-101) [Wallace]

Dean Wallace reported that a revised draft of the document will be in the mailing and requested that further discussion be deferred to the May agenda.

4.4 Bias Reduction Proposal (98-132) [Bridgewater]

Wally Bridgewater started his presentation by proposing that the bias be removed for Fast-80, having the host or the target supply the bias, and be able to turn it off during data phase. It developed that the proposal depends on the initiator knowing in advance when the target is switching to a data phase. Such knowledge would be required to change the bias quickly. The group discussed how to minimize the time required to switch the bias when changing in to or out of data phase, including the time needed to let the bus settle (or adjust to the bias change).

It was noted that the proposal allows compensation for some of the fixed tolerances currently present in the SPI-2 electrical signaling requirements. This led to a discussion of compensating for other tolerances by adding a signal integrity testing procedure to the protocol. Issues around the effects on higher protocol levels were raised. Wally agreed to bring a more detailed proposal to the next meeting.

Wally then repeated his request that the open circuit LVD driver voltage be reduced to 2.5 volts. Noting that the request depends on a long succession of possible future performance improvements in parallel SCSI, some present suggested that no changes should be made until we know more clearly where we are headed.

4.5 Dual Clocking Proposal (97-208) [Bastiani]

Vince Bastiani reported that dual-edge signal testing is still in progress and requested that further discussion be deferred to the May agenda.

4.6 Test results on dual edge signals (98-113r0) [Bastiani]

Vince Bastiani reported that testing is still in progress and requested that further discussion be deferred to the May agenda.

4.7 Testing results on hot plugging perturbations (98-129r0) [Gintz]

Bill Gintz presented some laboratory results on hot plugging. His experimental setup included a scope that triggered on between 50 and 100 millivolt swings on an ACK line in nanosecond time frames. The first scope triggered a second scope scanning at a hundred microseconds per division. This allowed for examination of both the high-speed and low-speed effects of hot plugging. Bill felt that some of his observed results were explained by the theoretical calculations described by Hank Herrman (see 4.1).

Bill noted several glitches on all of the lines he sampled. Bill was also concerned about transients caused by unplugging events, which have not been the focus of as much attention as the plugging events.

4.8 Packetized Protocol review (97-230r5) [Penokie/Williams]

George Penokie reviewed the packetized protocol proposal placed on the FTP site in December. The group commented on the proposal, noting several specific technical and typographical errors. It was agreed to remove

selection with ATN when information unit phases are enabled (unless the proposal authors can provide a justification for its presence in the standard). George stated his plan to revise the document for another round of review during the SCSI Working Group meeting.

4.9 QAS review (97-199r7 and 98-133r0) [Moore]

Richard Moore presented a overview (98-133r0) of latest revision of the Quick Arbitrate and Select (QAS) proposal (97-199r7).

Two expander vendors raised the concern that the installed base of their present design would be confused by the way the proposal deals with the BSY line. Unless the QAS proposal can be modified to accommodate such expanders, the use of QAS would need to be limited at configuration time. Also, the total bus length for many bus expander implementations might be reduced by some of the timing specifications in QAS. Still, those present felt that bus expanders can be built to support QAS.

Richard agreed to prepare a new revision of the QAS proposal for consideration at the May meeting.

4.10 CRC proposal for SPI-3 [Penokie]

George Penokie asked that item be deferred to the May meeting.

5. SPI-2 Topics

5.1 0.5 pF balance capacitance for LVD SCSI (98-131) [Aloisi/Kapraun]

Due to the late hour, discussion of this topic was moved to the SCSI Working Group meeting.

5.2 LVD ESD Concerns [Kapraun]

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5.3 Removal of overlapped commands (duplicate queue tags) checking in SPI-2 [Williams]

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5.5.2 SPI-2 Differential Cable Common Mode Voltage Requirements [Milligan]

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6. Meeting Schedule

The next meeting of SPI-3 Working Group will be May 4, 1998 in Colorado Springs, CO at the Doubletree World Arena Hotel (719-576-8900), hosted by Symbios, Inc. The meeting will begin at 9:00 a.m. on Monday.

7. Adjournment

The meeting was adjourned at 7:00 p.m. on Monday March 16, 1998.